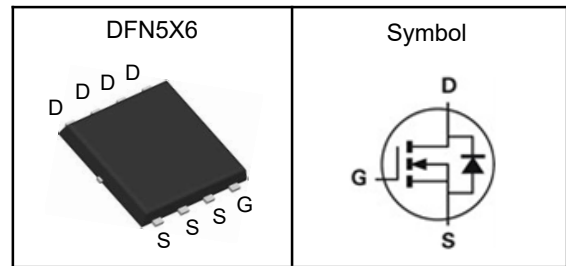


N-Channel Enhancement Mode MOSFET
Features

- High Speed Power Switching
- Reliable and Rugged
- ROHS Compliant
- 100% Avalanche Tested

Applications

- Power Management in Desktop Computer
- DC/DC Converters

Pin Description


V_{DSS}	120	V
$R_{DS(ON)-Typ}$	6.5	m Ω
I_D	90	A

Absolute Maximum Ratings ($T_C=25^\circ\text{C}$, Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V_{DSS}	Drain-Source Voltage	120	V
V_{GSS}	Gate-Source Voltage	± 20	V
T_J	Maximum Junction Temperature	-55 to 150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
$I_{DM}^{①}$	Pulse Drain Current Tested	360	A
I_D	Continuous Drain Current	90	A
P_D	Maximum Power Dissipation	125	W
E_{AS}	Avalanche Energy, Single pulse	100	mJ

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient	43	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance-Junction to Case	1.5	$^\circ\text{C}/\text{W}$

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150 $^\circ\text{C}$.

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz.



N-Channel Enhancement Mode MOSFET

Electrical Characteristics ($T_J=25^{\circ}\text{C}$, Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	120	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=120V, V_{GS}=0V$	---	---	1	μA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1	---	2.5	V
I_{GSS}	Gate Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	± 100	nA
$R_{DS(on)}$	Drain-Source On-state Resistance	$V_{GS}=10V, I_D=20A$	---	6.5	8	$m\Omega$
		$V_{GS}=4.5V, I_D=15A$	---	8	10	$m\Omega$
Dynamic Characteristics ^⑤						
gfs	Forward Transconductance	$V_{DS}=5V, I_D=10A$	---	43	---	S
C_{iss}	Input Capacitance	$V_{DS}=60V, V_{GS}=0V,$ $Freq.=1MHz$	---	3900	---	pF
C_{oss}	Output Capacitance		---	1360	---	
C_{rss}	Reverse Transfer Capacitance		---	20	---	
$T_{d(on)}$	Turn-on Delay Time	$V_{DS}=60V, V_{GS}=10V,$ $I_D=20A, R_G=6\Omega$	---	12	---	nS
T_r	Turn-on Rise Time		---	40	---	
$T_{d(off)}$	Turn-off Delay Time		---	30	---	
T_f	Turn-off Fall Time		---	38	---	
Q_g	Total Gate Charge	$V_{DS}=60V, V_{GS}=10V,$ $I_D=20A$	---	54	---	nC
Q_{gs}	Gate-Source Charge		---	13	---	
Q_{gd}	Gate-Drain Charge		---	7	---	
Source-Drain Characteristics						
V_{SD}	Diode Forward Voltage	$I_S=20A, V_{GS}=0V$	---	---	1.3	V
t_{rr}	Reverse Recovery Time	$I_F=20A, dI_F/dt=100A/\mu s$	---	54	---	nS
Q_{rr}	Reverse Recovery Charge		---	68	---	nC

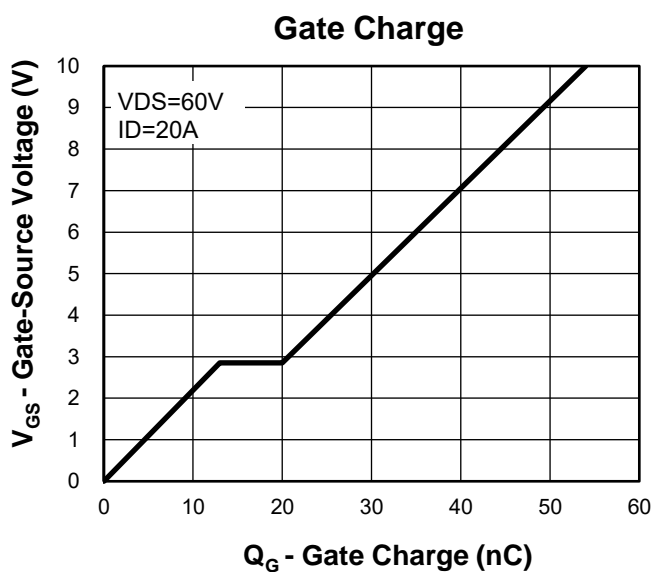
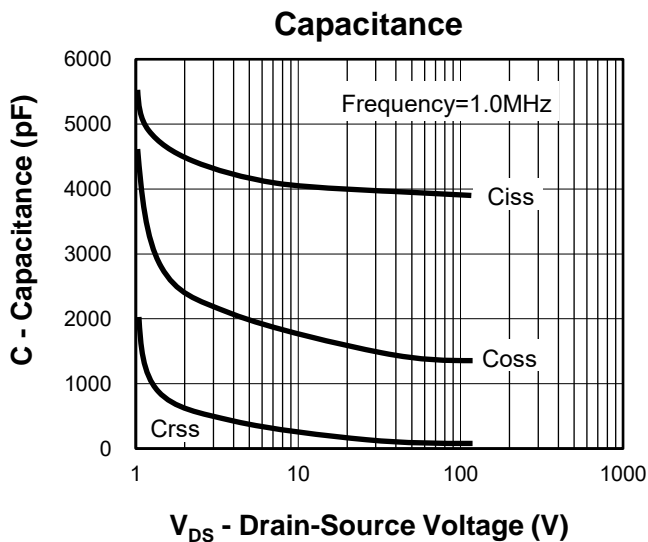
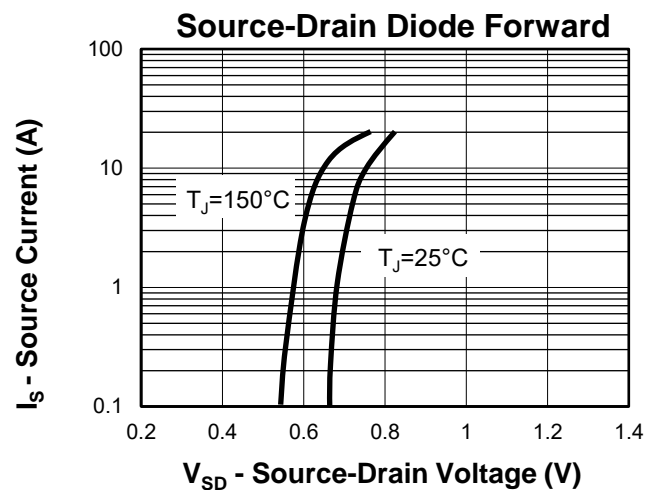
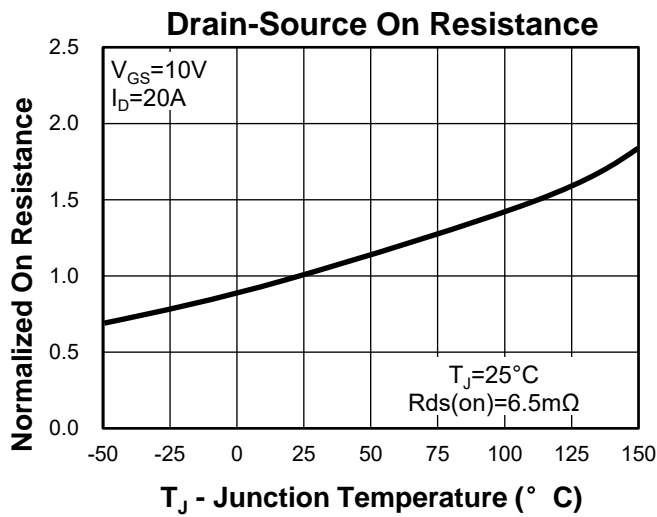
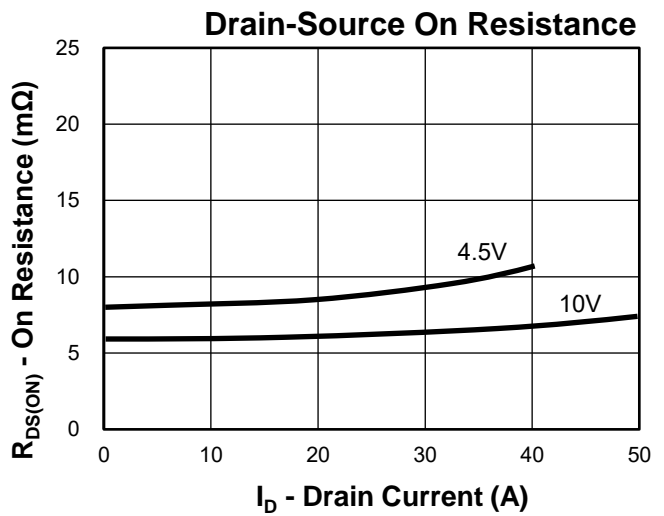
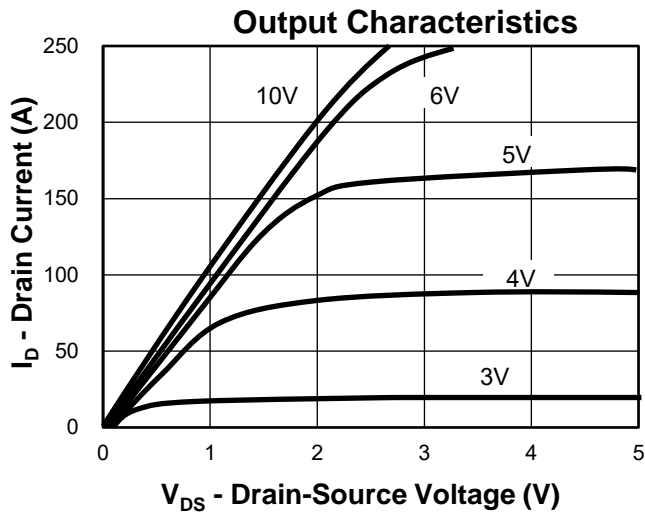
Note ④: Pulse test (pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$).

Note ⑤: Guaranteed by design, not subject to production testing.



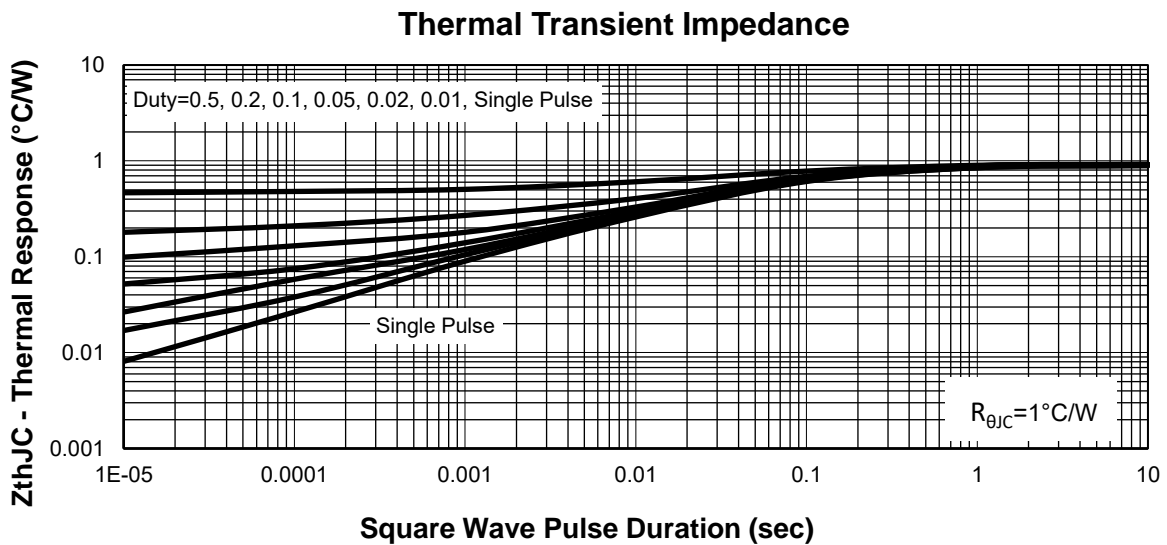
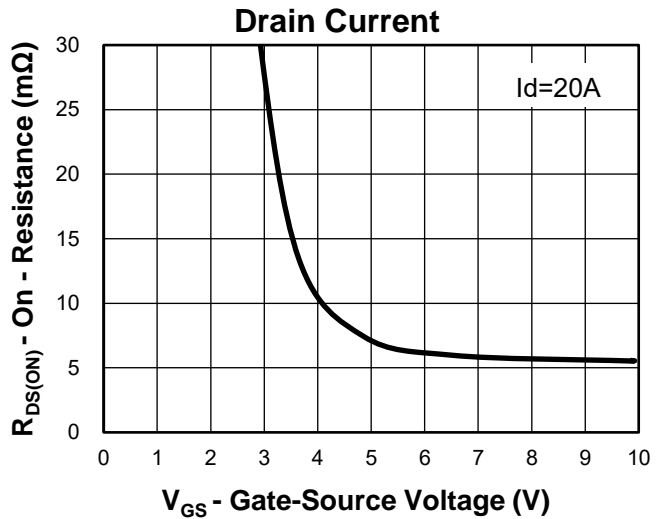
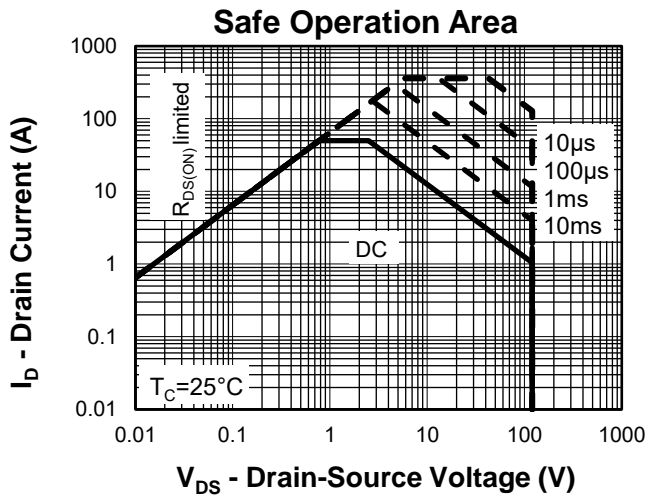
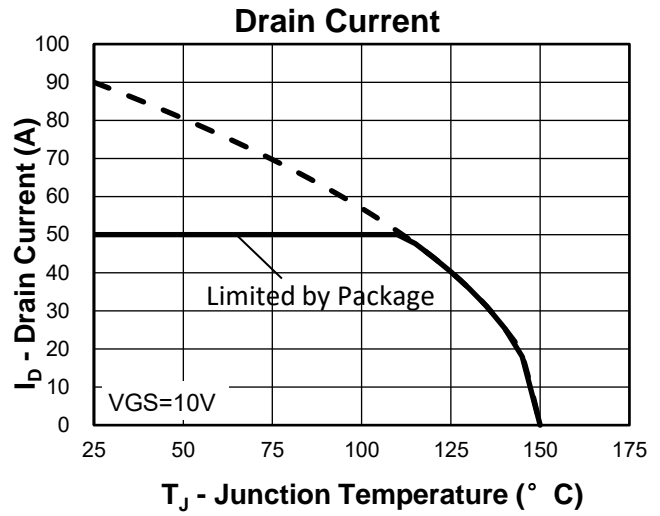
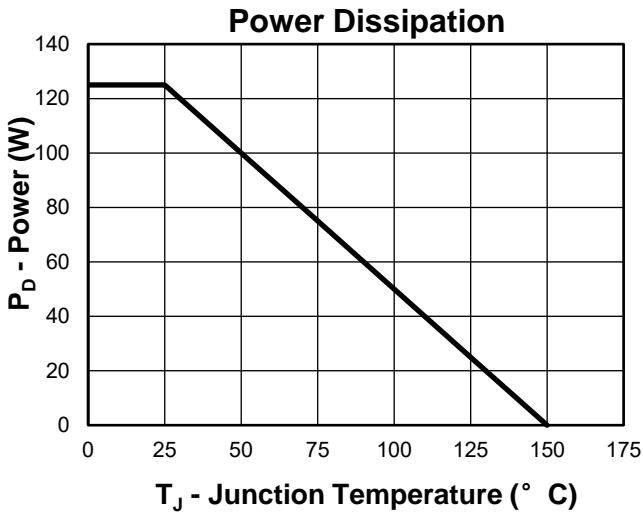
N-Channel Enhancement Mode MOSFET

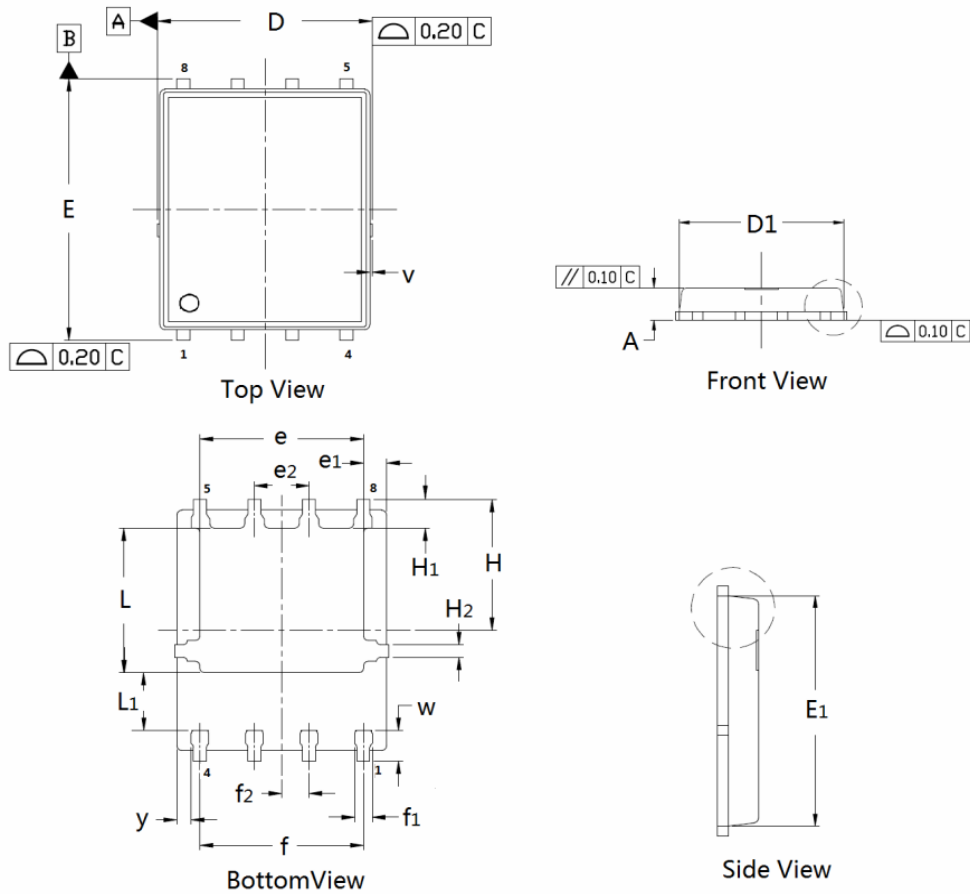
Typical Characteristics





N-Channel Enhancement Mode MOSFET



N-Channel Enhancement Mode MOSFET
DFN5×6 Package Outline Data

DIMENSIONS (unit : mm)

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	0.90	1.02	1.10	D	4.90	4.98	5.10
D ₁	4.80	4.89	5.10	E	5.90	6.11	6.25
E ₁	5.65	5.74	5.95	e	3.72	3.80	3.92
e ₁	--	0.5	--	e ₂	--	1.	--
f	--	3.8	--	f ₁	0.31	0.37	0.51
f ₂	--	0.6	--	H	--	3.	--
H ₁	0.59	0.63	0.79	H ₂	0.26	0.28	0.32
L	3.35	3.45	3.65	L ₁	--	1.	--
v	--	0.1	--	w	0.64	0.68	0.84
y	--	0.3	--				